

H7N0312AB

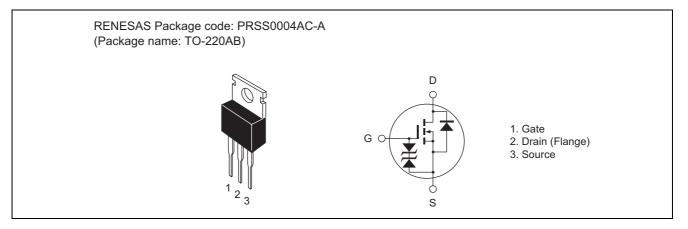
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1127-0400 (Previous: ADE-208-1571B) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS (on)} = 2.6 \text{ m}\Omega \text{ typ.}$
- Low drive current
- 4.5 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			(Ta = 25°C)
ltem	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	30	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	85	А
Drain peak current	I _{D (pulse)} Note 1	340	А
Body-drain diode reverse drain current	I _{DR}	85	А
Channel dissipation	Pch Note 2	125	W
Channel to case thermal impedance	θ ch-c	1.0	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25° C

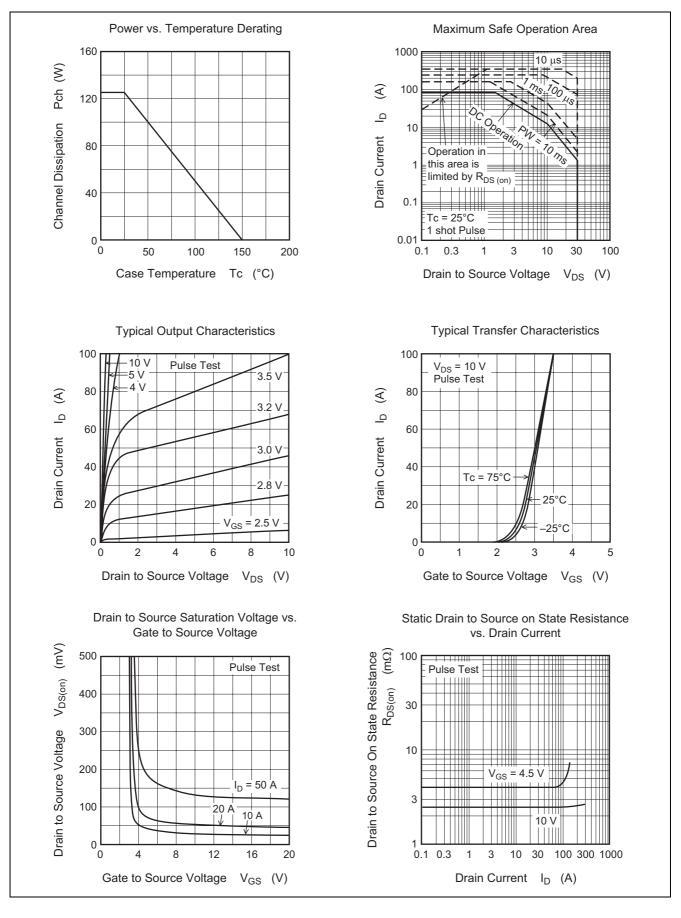
Electrical Characteristics

K eese			-			$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V (BR) DSS	30	—	—	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V (BR) GSS	±20	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	_	±10	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	10	μΑ	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS (off)}	1.0	—	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}^{\text{Note 3}}$
Static drain to source on state resistance	R _{DS (on)}		2.6	3.3	mΩ	$I_D = 42.5 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 3}}$
			4.0	5.8	mΩ	$I_D = 42.5 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note 3}$
Forward transfer admittance	y _{fs}	75	125		S	$I_D = 42.5 \text{ A}, V_{DS} = 10 \text{ V}^{Note 3}$
Input capacitance	Ciss		6900	—	pF	V _{DS} = 10 V
Output capacitance	Coss		1750	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss		820	—	pF	f = 1 MHz
Total gate charge	Qg		115	_	nC	V _{DD} = 10 V
Gate to source charge	Qgs		24	—	nC	V _{GS} = 10 V
Gate to drain charge	Qgd		24	_	nC	I _D = 85 A
Turn-on delay time	t _{d (on)}	—	45	_	ns	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 42.5 \text{ A}$
Rise time	tr		380	—	ns	$R_L = 0.24 \Omega$
Turn-off delay time	t _{d (off)}		125		ns	Rg = 4.7 Ω
Fall time	t _f	—	50		ns	
Body-drain diode forward voltage	V _{DF}		0.92		V	I _F = 85 A, V _{GS} = 0
Body-drain diode reverse recovery time	t _{rr}		75		ns	I _F = 85 A, V _{GS} = 0
						di _F /dt = 50 A/µs

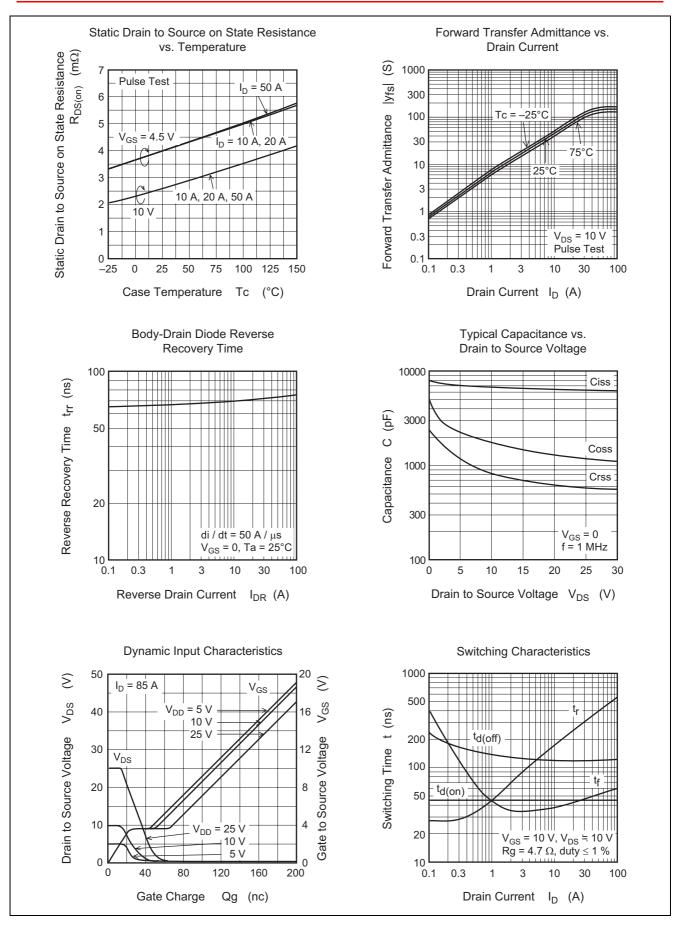
Note: 3. Pulse test



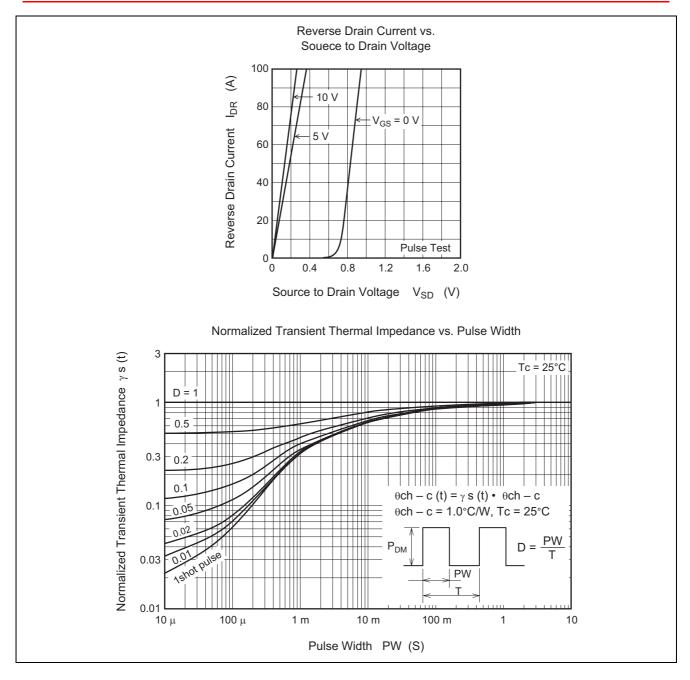
Main Characteristics





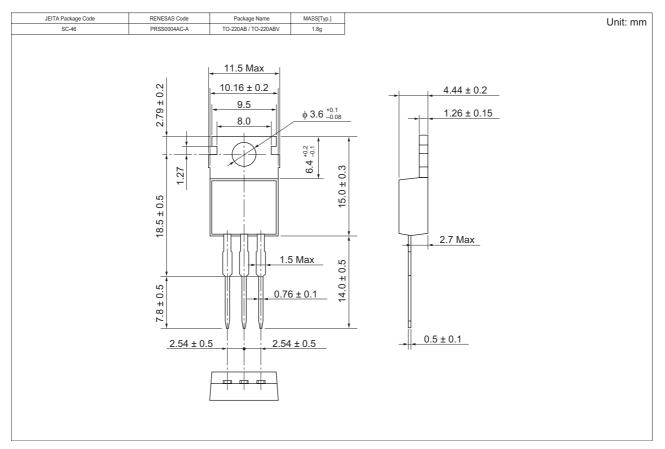








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H7N0312AB-E	500 pcs	Box (Sack)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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